

N-Channel 700V MOSFET

Description

The MSF11N70 is a N-channel enhancement-mode MOSFET, providing the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness. The TO-220F package is universally preferred for all commercial-industrial applications

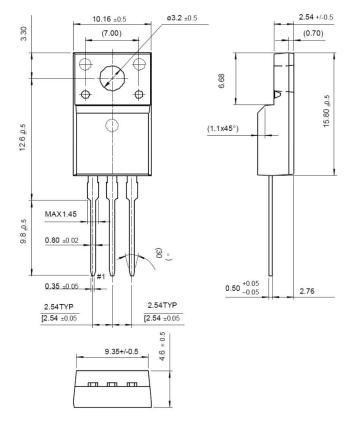
Features

- · Low On Resistance
- · Simple Drive Requirement
- · Low Gate Charge
- · Fast Switching Characteristic
- · RoHS compliant package available

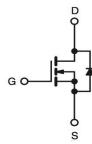
Packing & Order Information

50/Tube; 1,000/Box





Graphic symbol



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings					
Symbol	Parameter	Value	Unit		
V_{DS}	Drain-Source Voltage	700	V		
V _{GS}	Gate-Source Voltage	±30	V		
I _D	Continuous Drain Current @ TC=25°C	1.1	А		
	Continuous Drain Current @ TC=100°C	6.5	Α		
I_{DM}	Pulsed Drain Current	40	Α		
I _{AR}	Avalanche Current	10	А		
E _{AS}	Single Pulsed Avalanche Energy	658	mJ		
E _{AR}	Repetitive Avalanche Energy	17.8	mJ		
dv/dt	Peak Diode Recovery dv/dt	4.5	V/ns		



N-Channel 700V MOSFET

Absolute Maximum Ratings				
Symbol	Parameter	Value	Unit	
P_D	Power Dissipation (TC=25°C)	35	W	
	Power Dissipation (TC=100°C)	0.30	W/°C	
T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C	

NOTE:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L = 15mH, I_{AS} =9.0A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25°C
- 3. $I_{SD} \le 11.0 A$, di/dt $\le 200 A/us$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25 ^{\circ}C$
- 4. Pulse Test : Pulse Width ≤ 300µs, Duty Cycle ≤ 2%
- 5. Essentially Independent of Operating Temperature

Static Characteristics					
Symbol	Test Conditions	Min	Тур.	Max.	Units
V_{GS}	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.0		4.5	V
*R _{DS(ON)}	$V_{GS} = 10 \text{ V}$, $I_D = 5.0 \text{ A}$		0.9	1.2	mΩ
BV _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu A$	700			V
$\Delta BV_{DSS}/\Delta T_{J}$	I _D = 250μA, Referenced to 25°C		0.6		
I _{DSS}	$V_{DS} = 700 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 560 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 125^{\circ}\text{C}$			1 10	uA
I _{GSSF}	V _{DS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	V _{DS} = -30 V, V _{DS} = 0 V			-100	nA

Dynamic Characteristics					
Symbol	Test Conditions	Min	Тур.	Max.	Units
Q_g	$V_{DS} = 520 \text{ V}, I_{D} = 11 \text{ A},$ $V_{GS} = 10 \text{ V}$		48	58	nC
Q _{gs}			7.0		
Q_{gd}			18.0		
t _{d(on)}	$V_{DS} = 325 \text{ V}, I_{D} = 11 \text{ A},$ $R_{G} = 25 \Omega$		25	55	ns
t _r			70	150	ns
t _{d(off)}			140	300	ns
tf			80	165	ns
C _{ISS}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1.0 \text{MHz}$		1650	2050	pF
Coss			165	217	pF
C _{RSS}			18	25	pF



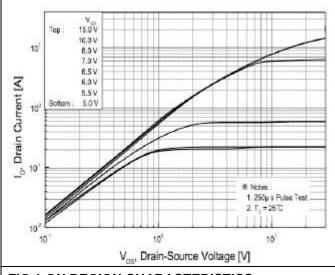
N-Channel 700V MOSFET

Symbol	Test Conditions	Min	Тур.	Max.	Units
Is				10	
I _{SM}				40	Α
V _{SD}	I _S = 11 A , V _{GS} = 0 V			1.4	V
t _{rr}	I _S = 11 A , V _{GS} = 0 V , dIF/dt=100A/μs		430		ns
Q _{rr}			4.3		nC



N-Channel 700V MOSFET

■Characteristics Curve



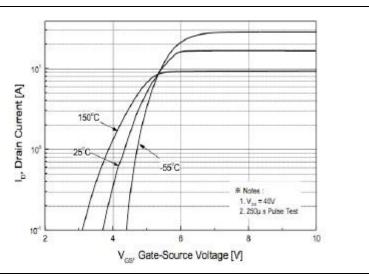


FIG.1-ON REGION CHARACTERISTICS

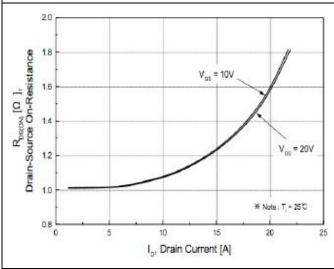


FIG.2-TRANSFER CHARACTERISTICS

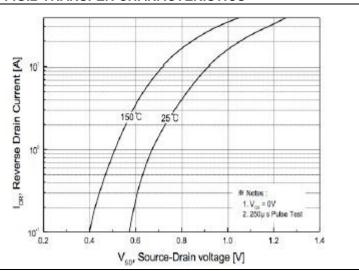


FIG.3-ON RESISTANCE VARIATION VS DRAIN CURRENT AND GATE VOLTAGE

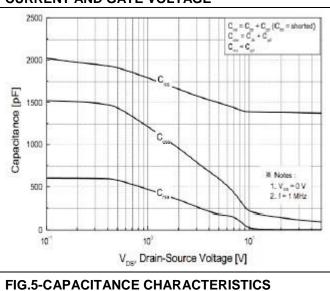


FIG.4-BODY DIODE FORWARD VOLTAGE VARIATION WITH SOURCE CURRENT AND TEMPERATURE

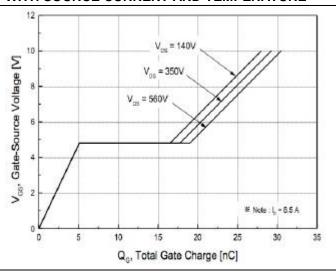
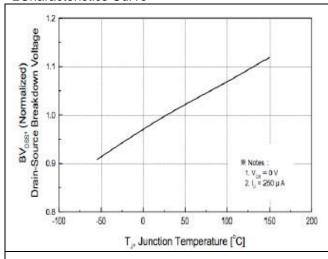


FIG.6-GATE CHARGE CHARACTERISTICS



N-Channel 700V MOSFET

■Characteristics Curve



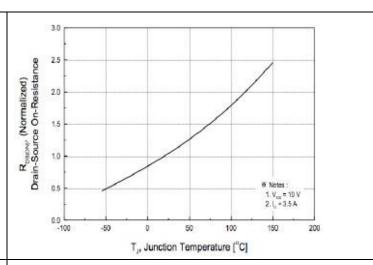


FIG.7-BREAKDOWN VOLTAGE VARIATION VS TEMPERATURE

Operation in This Area is Limited by R (100 µ.S)

100 µ.S

FIG.8-ON-RESISTANCE VARIATION VS TEMPERATURE

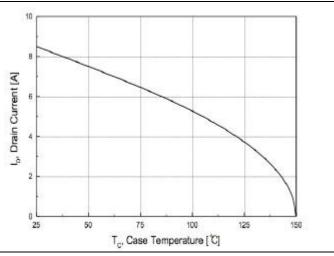
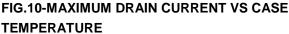


FIG.9-MAXIMUM SAFE OPERATING AREA



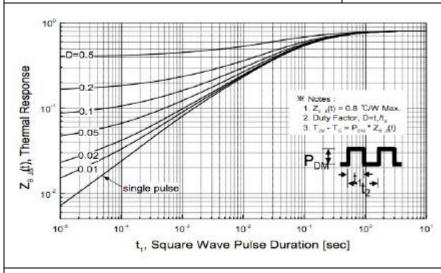


FIG.11-TRANSIENT THERMAL RESPONSE CURVE



N-Channel 700V MOSFET

■Characteristics Test Circuit & Waveform

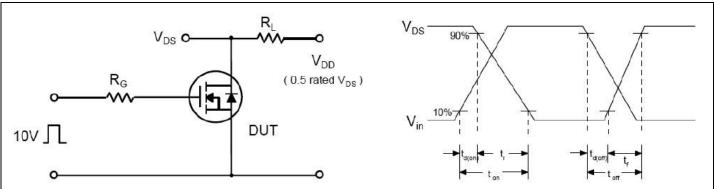


Fig 12. Resistive Switching Test Circuit & Waveforms

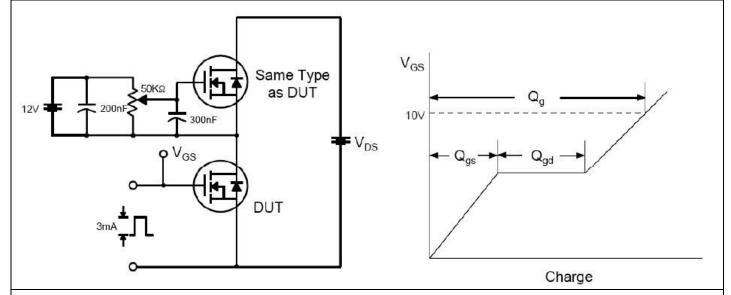


Fig 13. Gate Charge Test Circuit & Waveform

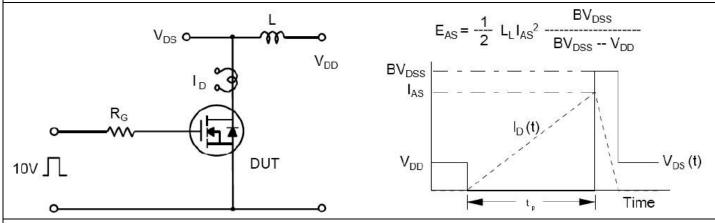


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms



N-Channel 700V MOSFET

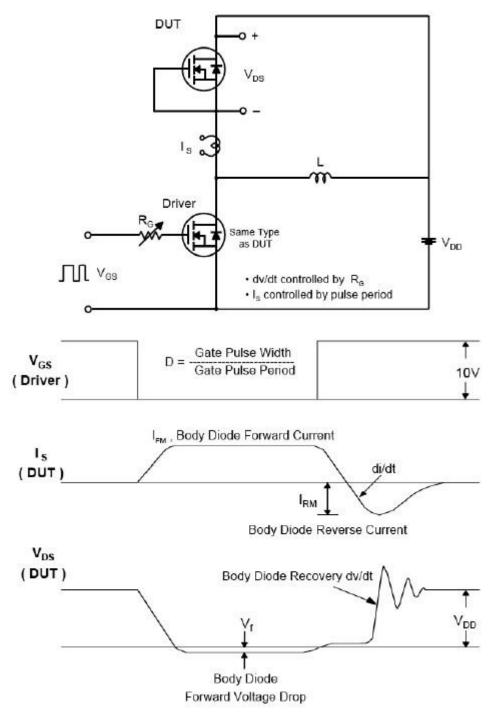


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



N-Channel 700V MOSFET

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